

Product Bulletin

Document #:PB24397X1 Issue Date:07 Oct 2022

Title of Change:	Update for PB24397X - to identify specific sites affected with the change including the transition period			
Effective date:	07 Oct 2022			
Contact information:	Contact your local onsemi Sales Office or KrisJudelo.Dayna@onsemi.com			
Type of notification:	This Product Bulletin is for notification purposes only. onsemi will proceed with implementation of this change upon publication of this Product Bulletin.			
Change Category:	Test Change			
Change Sub-Category(s):	Shipping/Packaging/Marking			
Sites Affected:				
onsemi Sites		External Foundry/Subcon Sites		
onsemi Cebu, Philippines		Greatek Electronics Inc., Taiwan		
onsemi Leshan, China		HANA Microelectronics, China		
onsemi Seremban, Malaysia		JCET, China		

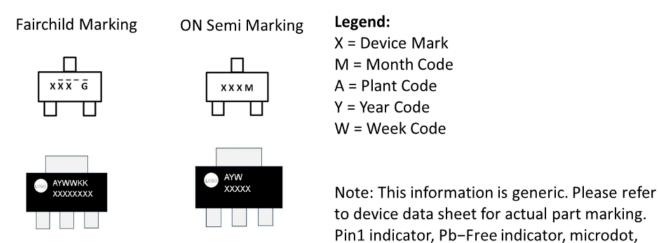
Description and Purpose:

This update to PB24397X is to list all of the affected sites and clarify that the transition period will be until Dec 31,2022. SOSM and SOT223 package assembled in various listed sites will start to use onsemi Marking Layout Configuration

This is part of the alignment and marking standardization.

For a specific OPN that is build in different sites will now have the same lay out scheme and will just differ on the plant code.

Sample marking change below



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may or may not be present.

Marking.

Some products may not follow the Generic



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List of Affected Standard Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

NDT3055L	NDT451AN	NDT452AP
NDT456P	NZT44H8	NZT45H8
NZT560	NZT560A	NZT605
NZT651	NZT660	NZT660A
NZT7053	NZT751	NZT753
NZT902	PZTA06	PZTA14
PZTA28	PZTA29	FDT86246L
FDC658P	PZTA64	PZTA56

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